

## **BB189**

# UHF variable capacitance diode Rev. 01 — 8 June 2009

**Product data sheet** 

## **Product profile**

## 1.1 General description

The BB189 is a planar technology variable capacitance diode in a SOD523 ultra small leadless plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

#### 1.2 Features

- Excellent linearity
- Excellent matching to 1.8 % DMA
- Ultra small plastic SMD package
- $C_{d(25V)}$ : 2.05 pF;  $C_{d(2V)}$  to  $C_{d(25V)}$  ratio: 6.3 min.
- Low series resistance

## 1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in UHF television tuners

#### **Pinning information** 2.

Table 1. **Pinning** 

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	JL
2	anode	1 2	
			sym008

<sup>[1]</sup> The marking bar indicates the cathode.

#### Ordering information 3.

Table 2. **Ordering information** 

Type number	Package		
	Name	Description	Version
BB189	SC-79	plastic surface-mounted package; 2 leads	SOD523



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## 4. Marking

Table 3. Marking codes

Type number	Marking code
BB189	4

## 5. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	reverse voltage		-	32	V
I <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		<b>–</b> 55	+150	°C
Tj	junction temperature		<b>–</b> 55	+125	°C

## 6. Characteristics

Table 5. Characteristics

 $T_i = 25 \,^{\circ}C$  unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	see Figure 2				
		V <sub>R</sub> = 30 V	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r <sub>s</sub>	diode series resistance	$f = 470 \text{ MHz}$ at $C_d = 9 \text{ pF}$	-	0.6	0.7	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 3</u>				
		V <sub>R</sub> = 2 V	14.15	-	15.75	pF
		V <sub>R</sub> = 25 V	1.89	-	2.18	pF
C <sub>d(2V)</sub> /C <sub>d(25V)</sub>	diode capacitance ratio (2 V to 25 V)	f = 1 MHz	6.3	-	-	
$\Delta C_d/C_d$	diode capacitance matching	$V_R = 2 V \text{ to } 25 V$ ; in sequence of 10 diodes (gliding)	-	-	1.8	%

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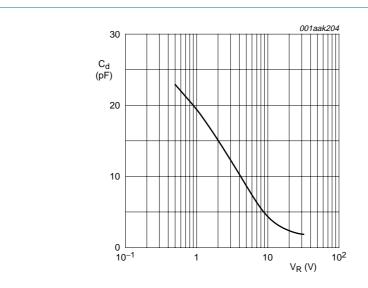


Fig 1. Diode capacitance as a function of reverse voltage; typical values

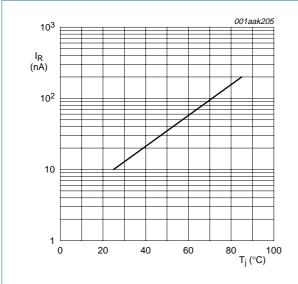
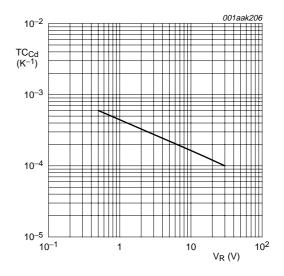


Fig 2. Reverse current as a function of junction temperature; maximum values



 $T_j = 0$  °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

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## 7. Package outline

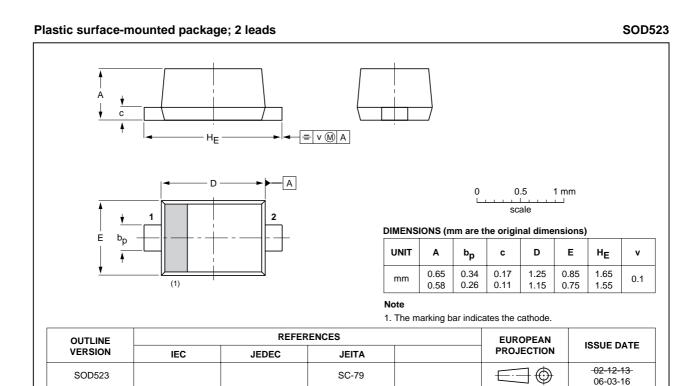


Fig 4. Package outline SOD523 (SC-79)

## 8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
UHF	Ultra High Frequency

## 9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB189_1	20090608	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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